



\*. C101 is a reworked part.

\*. Footprint of U1 on PCB is wrong. Need to swap pin 5 and 6.

PCB Number: PMP10467  
PCB Rev: A

PCB LOGO  
Texas Instruments

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Orderable: N/A	Designed for: Public Release	Mod. Date: 10/29/2014
TID #: PMP10467	Project Title: UCC28911 10W Flyback	
Number: PMP10467	Rev: A	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 3
Drawn By: S Yu	File: PMP10467_BlankSheet_SchDoc	Size: B
Engineer: S Yu	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	



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